

TSM104W, TSM104WA QUAD OPERATIONAL AMPLIFIER AND PROGRAMMABLE VOLTAGE REFERENCE SLOS478D-JULY 2005-REVISED AUGUST 2006

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FEATURES

- **OPERATIONAL AMPLIFIER**
 - Low Offset Voltage, Max of:
 - TSM104WA...3 mV (25°C) and 4 mV (Full Temperature)
 - TSM104W...5 mV (25°C) and 6 mV (Full **Temperature**)
 - Low Supply Current...375 µA/Channel Typ at $V_{CC} = 5 V$
 - Unity Gain Bandwidth...0.9 MHz Typ
 - Input Common-Mode Range Includes GND
 - Large Output-Voltage Swing...0 V to $V_{cc} - 2 V$
 - Wide Supply-Voltage Range...3 V to 30 V
 - 2-kV ESD Protection (HBM)
- VOLTAGE REFERENCE
 - Adjustable Output Voltage...V_{REF} to 36 V
 - V_{REF} = 2.5 V With Tight Tolerance, Max of:
 - TSM104WA...0.4% (25°C) and 0.8% (Full **Temperature**)
 - TSM104W...1% (25°C) and 2% (Full **Temperature**)
 - Low Temperature Drift...7 mV Typ Over **Operating Temperature Range**
 - Wide Sink-Current Range...0.5 mA Typ to 100 mA
 - Output Impedance...0.2 Ω Typ

DESCRIPTION/ORDERING INFORMATION

The TSM104W combines the building blocks of a guad operational amplifier and an adjustable voltage reference, both of which often are used in the control circuitry of switch-mode power supplies.

For the A grade, especially tight voltage regulation can be achieved through the low offset voltage for each operational amplifier (typically 0.5 mV) and tight tolerance for the voltage reference (0.4% at 25°C and 0.8% over operating temperature range).

The TSM104W and TSM104WA are characterized for operation from -40°C to 105°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

TYPICAL APPLICATIONS

- **Battery Chargers**
- Switch-Mode Power Supplies
- Linear Voltage Regulation
 - **Data-Acquisition Systems**



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ORDERING INFORMATION

T _A	MAX V _{IO} AND V _{REF} TOLERANCE (25°C)	PACK	TOP-SIDE MARKING		
		PDIP – N	Tube of 25	TSM104WAIN	PREVIEW
			Tube of 75	TSM104WAID	
	A grade	50IC - D	Reel of 2500	TSM104WAIDR	1 SIVI 104VVAI
	0 111, 0.170	TSSOP – PW	Tube of 75	TSM104WAIPW	SM404AL
40°C to 105°C			Reel of 2000	TSM104WAIPWR	- SIVI 104AI
-40°C 10 105°C		PDIP – N	Tube of 25	TSM104WIN	PREVIEW
			Tube of 75	TSM104WID	
	Standard grade 5 mV 1%	3010 - 0	Reel of 2500	TSM104WIDR	131/1104//1
	0		Tube of 75	TSM104WIPW	SM404I
		1330P - PW	Reel of 2000	TSM104WIPWR	SIVI 1 041

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

Absolute Maximum Ratings⁽¹⁾

over free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V _{CC}	Supply voltage			36	V
V _{ID}	Operational amplifier input differential voltage			36	V
VI	Operational amplifier input voltage range		-0.3	36	V
I_{KA}	Voltage reference cathode current			100	mA
		D package		73	
θ_{JA}	Package thermal impedance ⁽²⁾⁽³⁾	N package		67	°C/W
		al voltage 36 ange -0.3 36 100 D package 73 N package 67 PW package 108 -65 150			
TJ	Maximum junction temperature			150	°C
T _{stg}	Storage temperature range		-65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) - T_A)/\theta_{JA}$. Selecting the maximum of 150°C can affect reliability.

(3) The package thermal impedance is calculated in accordance with JESD 51-7.

Recommended Operating Conditions

		MIN	MAX	UNIT
$V_{CC+} - V_{CC-}$	Supply voltage	3	30	V
I _K	Cathode current	1	100	mA
T _A	Operating free-air temperature	-40	105	°C

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Total Device Electrical Characteristics

	PARAMETER	TEST CONDITIONS	TA	MIN	TYP	MAX	UNIT
	Total supply current,	$V_{CC+} = 5 V$, No load	Full rongo		1.4	2.4	m (
ICC	excluding cathode-current reference	$V_{CC+} = 30 V$, No load			4	IIIA	

Operational Amplifier Electrical Characteristics

 V_{CC+} = 5 V, V_{CC-} = GND, V_O = 1.4 V, T_A = 25°C (unless otherwise noted)

	PARAMETER		TEST CONDITIONS	T _A	MIN	TYP	MAX	UNIT	
		TOMAGANA		25°C		1	5		
	land offerstandland	151010400		Full range			6		
v _{IO}	input offset voltage	TONACAWA		25°C		0.5	3	mv	
		15M104WA		Full range			4		
αV_{IO}	Input offset voltage d	rift		25°C		7		μV/°C	
	Innut offerst ourrest			25°C		2	30	~^	
IIO	input offset current			Full range			50	nA	
	Innut high ourrent			25°C		30	150	~^	
IB	input bias current			Full range			200	ΠA	
٨		acia	$V_{CC+} = 15 \text{ V}, \text{ R}_{1} = 2 \text{ k}\Omega,$	25°C	50	100		\//m>\/	
A _{VD}	Large-signal voltage	yam	$V_0 = 1.4 \text{ V to } 11.4 \text{ V}$	Full range	25			v/mv	
k _{SVR}	Supply-voltage rejection	ion ratio	$V_{CC+} = 5 V \text{ to } 30 V$	25°C	65	100		dB	
N			V 20.V(1)	25°C	0		V _{CC+} – 1.5	N/	
VICR	Input common-mode	voltage range	$v_{CC+} = 30 v^{(1)}$	Full range	0		$V_{CC+} - 2$	V	
CMDD	CMRR Common-mode rejection ratio			25°C	70	85			
CMRR				Full range	60			aв	
I _{source}	Output source curren	t	$V_{CC+} = 15 \text{ V}, V_O = 2 \text{ V}, V_{id} = 1 \text{ V}$	25°C	20	40		mA	
I _{SC}	Short circuit to GND		V _{CC+} = 15 V	25°C		40	60	mA	
l _{sink}	Output sink current		$V_{CC+} = 15 \text{ V}, V_O = 2 \text{ V}, V_{id} = -1 \text{ V}$	25°C	10	20		mA	
V			V 20 V B 10 KO	25°C	27	28		V	
⊻он		aye	$v_{CC+} = 50 v, R_L = 10 RS2$	Full range	27			v	
V			P 10 KO	25°C		5	20	m)/	
VOL	Low-level output volta	ige	$R_{L} = 10 \text{ kg}$	Full range			20	mv	
SR	Slew rate at unity gain	n	$ \begin{array}{l} V_{CC+} = 15 \ V, \ C_L = 100 \ p\text{F}, \\ R_L = 2 \ k\Omega, \ V_I = 0.5 \ V \ to \ 3 \ V, \\ unity \ gain \end{array} $	25°C	0.1	0.3		V/µs	
GBW	Gain bandwidth produ	uct		25°C	0.5	0.9		MHz	
THD	Total harmonic distor	tion	$ \begin{array}{l} V_{CC+} = 30 \ V, \ V_O = 2 \ V_{pp}, \\ C_L = 100 \ pF, \ R_L = 2 \ k\Omega, \\ f = 1 \ kHz, \ A_V = 20 \ dB \end{array} $	25°C		0.01		%	
V _n	Equivalent input noise	e voltage	$V_{CC} = 30 \text{ V}, \text{ R}_{S} = 100 \Omega,$ f = 1 kHz	25°C		25		nV/√ Hz	
	Channel separation		1 kHz < f < 20 kHz	25°C		120		dB	

(1) The input common-mode voltage of either input should not be allowed to go below -0.3 V. The upper end of the common-mode voltage range is $V_{CC+} - 1.5$ V, but either input can go to $V_{CC+} + 0.3$ V without damage (absolute maximum ratings still must be observed).

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Voltage Reference Electrical Characteristics

	PARAMETER		TEST CONDITIONS	T _A	MIN	TYP	MAX	UNIT	
		TOMADAW	1 10 m	25°C	2.475	2.5	2.525		
V	Poforonoo voltago	131/1104/	$I_{K} = 10 \text{ mA}$	Full range	2.45		2.55		
V REF	Reference vollage		1 - 10 m	25°C	2.49	2.5	2.51	v	
		13101104VVA	$I_{K} = 10 \text{ mA}$	Full range	2.48		2.52		
ΔV_{REF}	Reference input voltage deviation over temperature range		$V_{KA} = V_{REF}$, $I_K = 10$ mA	Full range		7	30	mV	
$\frac{\Delta V_{REF}}{\Delta V_{KA}}$	Ratio of change in reference voltage to change in cathode voltage		$V_{KA} = 3 V$ to 36 V, $I_K = 10 mA$	25°C	-2	-1.1		mV/V	
	Deference input ourrent		1 10 m	25°C		1.5	2.5	۵	
REF	Reference input current		$I_{K} = 10 \text{ mA}$	Full range			3	μΑ	
ΔI_{REF}	Reference input current deviation over temperature range			Full range		0.8	1.2	μA	
I _{min}	Minimum cathode current for regulation		$V_{KA} = V_{REF}$	25°C		0.5	1	mA	
I _{K,OFF}	Off-state cathode current			25°C		180	500	nA	
z _{ka}	Dynamic impedance ⁽¹⁾		$V_{KA} = V_{REF}$, f < 1 kHz, $\Delta I_{K} = 1$ mA to 100 mA	25°C		0.2	0.5	Ω	

$$|z_{ka}| = \frac{\Delta V_{KA}}{\Delta I_{K}}$$

(1) The dynamic impedance is defined as



AMPLIFIER NOISE VOLTAGE

vs FREQUENCY

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TYPICAL OPERATING CHARACTERISTICS

 $T_{A} = 25^{\circ}C$ (unless otherwise noted)



TOTAL HARMONIC DISTORTION (THD)











Figure 4.

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TYPICAL OPERATING CHARACTERISTICS (continued)

 $T_A = 25^{\circ}C$ (unless otherwise noted)





PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead finish/	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	Ball material	(3)		(4/5)	
TSM104WAID	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 105	TSM104WAI	Samples
TSM104WAIDR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 105	TSM104WAI	Samples
TSM104WAIPWR	ACTIVE	TSSOP	PW	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 105	SM104AI	Samples
TSM104WIDR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 105	TSM104WI	Samples
TSM104WIPWR	ACTIVE	TSSOP	PW	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 105	SM104I	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



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Texas

*All dimensions are nominal

STRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TSM104WAIDR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
TSM104WAIPWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
TSM104WIDR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
TSM104WIPWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1



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PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TSM104WAIDR	SOIC	D	16	2500	356.0	356.0	35.0
TSM104WAIPWR	TSSOP	PW	16	2000	356.0	356.0	35.0
TSM104WIDR	SOIC	D	16	2500	356.0	356.0	35.0
TSM104WIPWR	TSSOP	PW	16	2000	356.0	356.0	35.0

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TUBE



- B - Alignment groove width

*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
TSM104WAID	D	SOIC	16	40	506.6	8	3940	4.32

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



PW0016A



PACKAGE OUTLINE

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.



PW0016A

EXAMPLE BOARD LAYOUT

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



PW0016A

EXAMPLE STENCIL DESIGN

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

9. Board assembly site may have different recommendations for stencil design.



^{8.} Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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